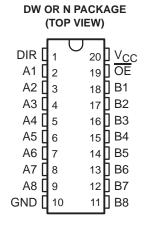
SN74ALS638A, SN74ALS639A, SN74AS638A, SN74AS639 OCTAL BUS TRANSCEIVERS

SDAS123A - DECEMBER 1983 - REVISED JANUARY 1995

- Bidirectional Bus Transceivers in High-Density 20-Pin Packages
- Choice of True or Inverting Logic
- A-Bus Outputs Are Open Collector;
 B-Bus Outputs Are 3 State
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic (N) 300-mil DIPs

DEVICE	A OUTPUT		
SN74ALS638A, SN74AS638A	Open collector	3 state	Inverting
SN74ALS639A, SN74AS639	Open collector	3 state	True



description

These octal bus transceivers are designed for asynchronous two-way communication between open-collector and 3-state buses. The devices transmit data from the A bus (open-collector) to the B bus (3 state) or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so the buses are isolated.

The -1 version of SN74ALS638A is identical to the standard version, except that the recommended maximum I_{OL} is increased to 48 mA.

The SN74ALS638A, SN74ALS639A, SN74AS638A, and SN74AS639 are characterized for operation from 0°C to 70°C.

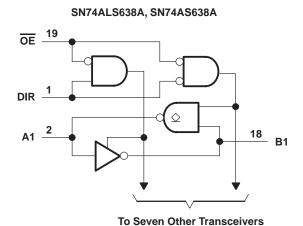
FUNCTION TABLE

ı	INP	UTS	OPER.	ATION
	ŌĒ	DIR	SN74ALS638A SN74AS638A	SN74ALS639A SN74AS639
I	L	L	B data to A bus	B data to A bus
	L	Н	A data to B bus	A data to B bus
	Н	Χ	Isolation	Isolation

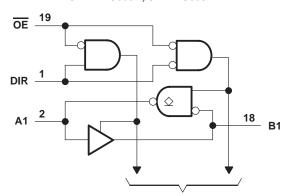
logic symbols†

SN74ALS638A, SN74AS638A SN74ALS639A, SN74AS639 19 OE OE G3 G3 DIR 3 EN1 [BA] DIR 3 EN1 [BA] 3 EN2 [AB] 3 EN2 [AB] 18 18 **☆1 B**1 **∆1** ◁ **B**1 \triangleleft 2▽ 17 17 3 B2 B2 16 4 16 В3 **A3 B3** 5 15 5 15 **B4** B4 6 14 6 14 Α5 **B5 A5 B5** 7 13 13 **A6 B6 A6 B6** 8 12 8 12 **B7 B7** Α7 9 11 9 11 **B8 B8 8**A **A8**

logic diagrams (positive logic)



SN74ALS639A, SN74AS639



To Seven Other Transceivers

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V _{CC} 7 V
Input voltage, V _I : All inputs
A-bus I/O ports 7 V
B-bus I/O ports 5.5 V
Operating free-air temperature range, T _A : SN74ALS638A, SN74ALS639A
Storage temperature range –65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

SDAS123A - DECEMBER 1983 - REVISED JANUARY 1995

recommended operating conditions

			_	74ALS63 74ALS63	-	UNIT
			MIN	NOM	MAX	
Vcc	Supply voltage		4.5	5	5.5	V
V _{IH} High-level input voltage						V
VIL	V _{IL} Low-level input voltage				0.8	V
Vон	High-level output voltage	A ports			5.5	V
IOH	High-level output current	B ports			-15	mA
la.	Laurian al antentament				24	mA
IOL	Low-level output current	A or B ports			48†	IIIA
TA	T _A Operating free-air temperature				70	°C

 $^{^\}dagger$ Applies only to the SN74ALS638A-1 version and only if V_{CC} is between 4.75 V and 5.25 V

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDIT	TEST CONDITIONS			8A 9A	UNIT
						MAX	
٧ıK		$V_{CC} = 4.5 V,$	$I_{I} = -18 \text{ mA}$			-1.5	V
loh	A ports	$V_{CC} = 4.5 V,$	V _{OH} = 5.5 V			0.1	mA
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2	2		
Vон	B ports	V _{CC} = 4.5 V	$I_{OH} = -3 \text{ mA}$	2.4	3.2		V
		VCC = 4.5 V	$I_{OH} = -15 \text{ mA}$	2			
			I _{OL} = 12 mA		0.25	0.4	
VOL	A or B ports	$V_{CC} = 4.5 V$	I _{OL} = 24 mA		0.35	0.5	V
			I _{OL} = 48 mA [†]		0.35	0.5	
1.	Control inputs	V 55V	V _I = 7 V			0.1	Λ
l _I	A or B ports	$V_{CC} = 5.5 V$	5 V V _I = 5.5 V			0.1	mA
	Control inputs	V 55V				20	Δ
lН	A or B ports§	$V_{CC} = 5.5 V,$	$V_1 = 2.7 \text{ V}$			20	μΑ
	Control inputs	V 55V	V 0.4V			-0.1	^
ΙIΓ	A or B ports§	$V_{CC} = 5.5 V,$	$V_I = 0.4 V$			-0.1	mA
IO¶	B ports	V _{CC} = 5.5 V,	V _O = 2.25 V	-30		-112	mA
			Outputs high		18	30	
	SN74ALS638A		Outputs low		26	41	
			Outputs disabled		16	30	A
ICC			Outputs high		25	40	mA
	SN74ALS639A	N74ALS639A V _{CC} = 5.5 V			30	50	
			Outputs disabled		33	54	

[†] Applies only to the SN74ALS638A-1 version and only if V_{CC} is between 4.75 V and 5.25 V



 $[\]ddagger$ All typical values are at VCC = 5 V, TA = 25°C. § For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

SN74ALS638A, SN74ALS639A, SN74AS638A, SN74AS639 OCTAL BUS TRANSCEIVERS

SDAS123A - DECEMBER 1983 - REVISED JANUARY 1995

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C _L = 50 R _L = 68 R1 = R	30 Ω (A	outputs), Ω (B outpi	uts),	UNIT
			SN74AL	S638A	SN74AL	S639A	
			MIN	MAX	MIN	MAX	
^t PLH	А		2	12	2	12	ns
^t PHL	Α	В	2	12	2	12	115
t _{PLH}	В	Δ.	8	25	10	30	ns
^t PHL	В	А	8	30	5	22	115
^t PLH	ŌĒ		5	25	10	30	ns
^t PHL	OE	А	10	45	10	35	110
^t PZH			5	20	6	21	
t _{PZL}	ŌĒ	В	5	22	8	25	ns
^t PHZ	ŌĒ	В	2	10	2	10	
t _{PLZ}	OE .	D	3	15	3	16	ns

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V _{CC}	
Input voltage, V _I : All inputs	7 V
A-bus I/O ports	
B-bus I/O ports	5.5 V
Operating free-air temperature range, T _A : SN74AS638A, SN74AS639	0°C to 70°C
Storage temperature range	-65° C to 150° C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

				74AS638 N74AS63	-	UNIT
			MIN	NOM	MAX	
Vcc	Supply voltage		4.5	5	5.5	V
VIH	High-level input voltage		2			V
V _{IL}	Low-level input voltage				0.8	V
Vон	High-level output voltage	A ports			5.5	V
ІОН	High-level output current	B ports			-15	mA
l _{OL}	Low-level output current	A or B ports			64	mA
TA	Operating free-air temperature		0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER TEST CONDITIONS		TEST CONDIT	TIONS		74AS63 174AS63	-	UNIT
			MIN	TYP [†]	MAX		
VIK		V _{CC} = 4.5 V,	I _I = -18 mA			-1.2	V
loh	A ports	V _{CC} = 4.5 V,	V _{OH} = 5.5 V			0.1	mA
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -2 \text{ mA}$	V _{CC} -2	!		
VOH	B ports	V = = - 4 5 V	IOH = -3 mA	2.4	3.2		V
		$V_{CC} = 4.5 V$	$I_{OH} = -15 \text{ mA}$	2.4			
VOL	A or B ports	V _{CC} = 4.5 V,	I _{OL} = 64 mA		0.35	0.55	V
	Control inputs	V 55V	V _I = 7 V			0.1	Λ
'	A or B ports	$V_{CC} = 5.5 V$	V _I = 5.5 V			0.1	mA
	Control inputs	V 55V				20	^
ΙΗ	A or B ports‡	$V_{CC} = 5.5 V$,	V _I = 2.7 V			70	μΑ
	Control inputs	V 55V	V 0.4V			-0.5	Δ
¹IL	A or B ports‡	$V_{CC} = 5.5 V$,	V _I = 0.4 V			-0.75	mA
IO§		V _{CC} = 5.5 V,	V _O = 2.25 V	-50		-150	mA
			Outputs high		24	54	
	SN74AS638A	V _C C = 5.5 V	Outputs low		75	122	
l			Outputs disabled		37	61	A
Icc			Outputs high		56	92	mA
	SN74AS639 V _{CC} = 5.5 V		Outputs low		95	154	
			Outputs disabled		62	100	

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	R1 = R2 T _A = MI	pF, 0 Ω (A α 2 = 500 Ω N to MA	outputs), 2 (B outp X¶	outs),	UNIT
			SN74A		SN74A		
			MIN	MAX	MIN	MAX	
^t PLH	Α	В	2	7	2	9.5	ns
^t PHL	7	Ь	2	6.5	2	9	113
tpLH	В		5	20	5	22	ns
t _{PHL}	Ь	А	2	7	2	9	115
tPLH	<u>OE</u>	Δ.	5	19	5	21.5	ns
^t PHL	ÜE	А	2	9	2	11.5	115
^t PZH	ŌĒ		2	8	2	10.5	20
tPZL	ÜE	В	2	10	2	10.5	ns
^t PHZ	ŌĒ	В	2	7	2	7	ns
t _{PLZ}	OE .	٥	2	10	2	10.5	113

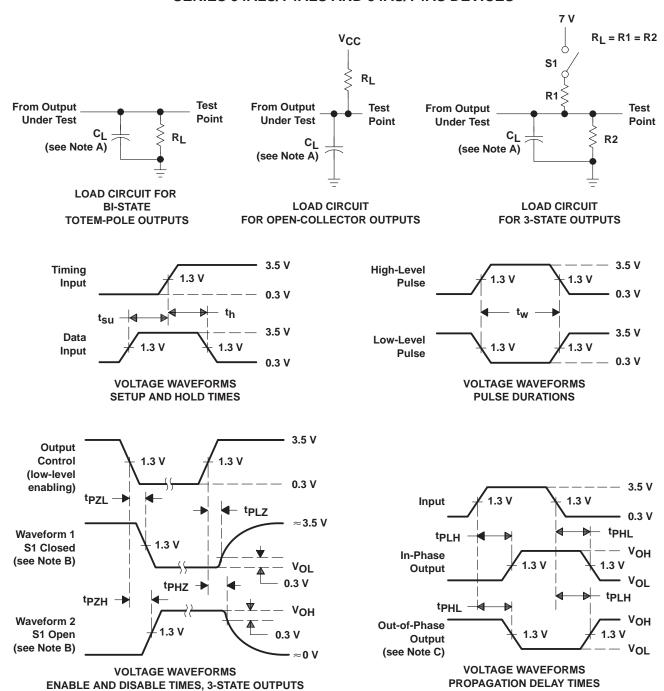
[¶] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

[§] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, los.

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
 - D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_{Γ} = t_{f} = 2 ns, duty cycle = 50%.
 - E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms





PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74ALS638A-1DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS638A-1DWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS638A-1DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS638A-1N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ALS638A-1NE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ALS638A-1NSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS638A-1NSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS638ADW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS638ADWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS638AN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ALS638ANE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ALS638ANSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS638ANSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS639ADW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS639ADWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS639ADWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS639ADWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS639AN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ALS639ANE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ALS639ANSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS639ANSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AS638AN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74AS638ANE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74AS638ANSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AS638ANSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM



PACKAGE OPTION ADDENDUM

12-Jan-2006

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74AS639DW	OBSOLETE	SOIC	DW	20	TBD	Call TI	Call TI
SN74AS639DWR	OBSOLETE	SOIC	DW	20	TBD	Call TI	Call TI
SN74AS639N	OBSOLETE	PDIP	N	20	TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

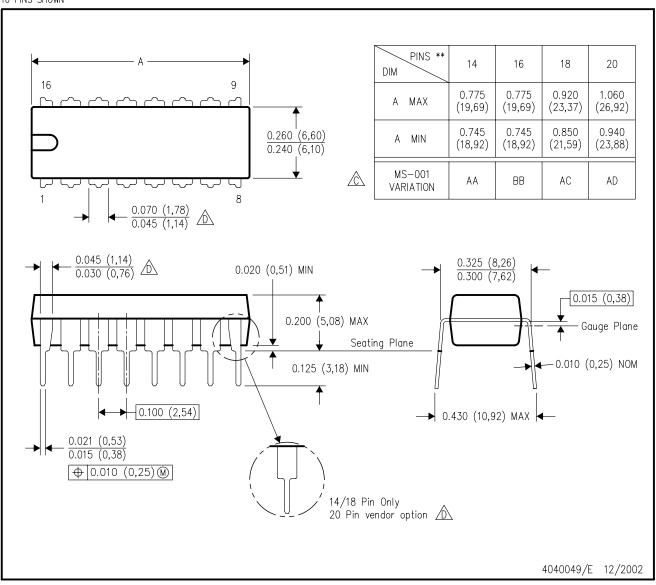
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N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



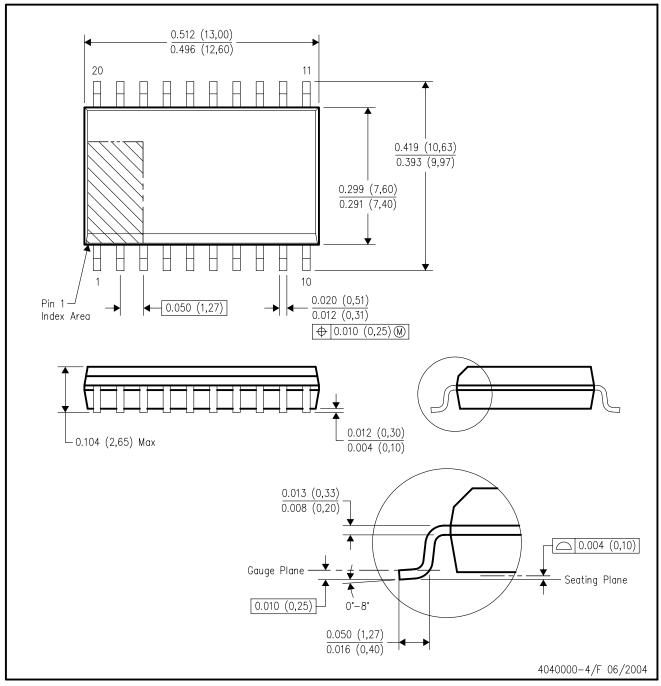
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AC.

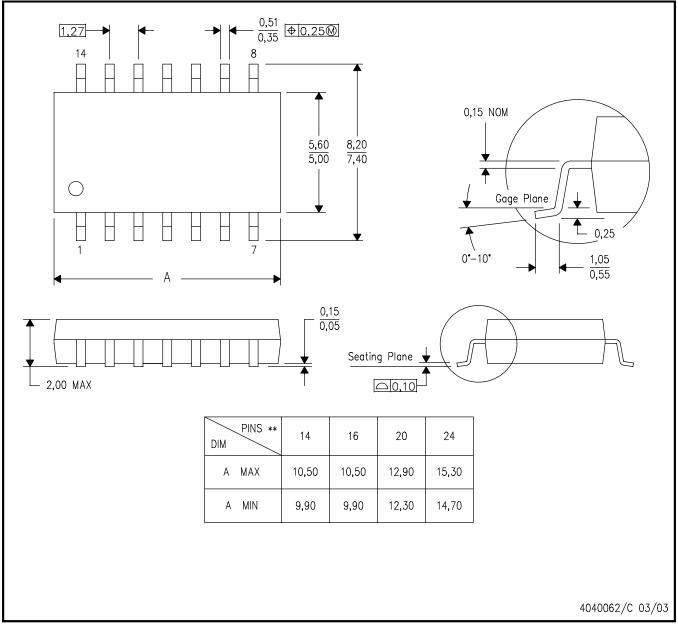


MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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